

Höchstzulässige Werte / maximum rated values

Elektrische Eigenschaften / electrical properties

Kollektor Emitter Sperrspannung collector emitter voltage	$T_{vj} = 25^{\circ}\text{C}$	V_{CES}	1200	V
Kollektor Dauergleichstrom DC collector current	$T_c = 80^{\circ}\text{C}$	$I_{C, nom}$	300	A
	$T_c = 25^{\circ}\text{C}$	I_C	480	A
Periodischer Kollektor Spitzenstrom repetitive peak collector current	$t_p = 1\text{ms}, T_c = 80^{\circ}\text{C}$	I_{CRM}	600	A
Gesamt Verlustleistung total power dissipation	$T_c = 25^{\circ}\text{C}, \text{Transistor}$	P_{tot}	1470	W
Gate Emitter Spitzenspannung gate emitter peak voltage		V_{GES}	+/- 20	V
Dauergleichstrom DC forward current		I_F	300	A
Periodischer Spitzenstrom repetitive peak forward current	$t_p = 1\text{ms}$	I_{FRM}	600	A
Grenzlastintegral I^2t value	$V_R = 0\text{V}, t_p = 10\text{ms}, T_{vj} = 125^{\circ}\text{C}$	I^2t	19	kA^2s
Isolations Prüfspannung insulation test voltage	RMS, $f = 50\text{Hz}, t = 1\text{min.}$	V_{ISOL}	2,5	kV

Charakteristische Werte / characteristic values

Transistor Wechselrichter / transistor inverter

			min.	typ.	max.	
Kollektor Emitter Sättigungsspannung collector emitter saturation voltage	$I_C = 300\text{A}, V_{GE} = 15\text{V}, T_{vj} = 25^{\circ}\text{C}$	V_{CESat}	-	1,7	2,15	V
	$I_C = 300\text{A}, V_{GE} = 15\text{V}, T_{vj} = 125^{\circ}\text{C}$		-	2,0	-	V
Gate Schwellenspannung gate threshold voltage	$I_C = 12\text{mA}, V_{CE} = V_{GE}, T_{vj} = 25^{\circ}\text{C}$	$V_{GE(th)}$	5,0	5,80	6,50	V
Gateladung gate charge	$V_{GE} = -15\text{V} \dots +15\text{V}$	Q_G	-	2,80	-	μC
Eingangskapazität input capacitance	$f = 1\text{MHz}, T_{vj} = 25^{\circ}\text{C}, V_{CE} = 25\text{V}, V_{GE} = 0\text{V}$	C_{ies}	-	21	-	nF
Rückwirkungskapazität reverse transfer capacitance	$f = 1\text{MHz}, T_{vj} = 25^{\circ}\text{C}, V_{CE} = 25\text{V}, V_{GE} = 0\text{V}$	C_{res}	-	0,85	-	nF
Kollektor Emitter Reststrom collector emitter cut off current	$V_{CE} = 1200\text{V}, V_{GE} = 0\text{V}, T_{vj} = 25^{\circ}\text{C}$	I_{CES}	-	-	5	mA
Gate Emitter Reststrom gate emitter leakage current	$V_{CE} = 0\text{V}, V_{GE} = 20\text{V}, T_{vj} = 25^{\circ}\text{C}$	I_{GES}	-	-	400	nA

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Charakteristische Werte / characteristic values

Transistor Wechselrichter / transistor inverter

			min.	typ.	max.	
Einschaltverzögerungszeit (induktive Last) turn on delay time (inductive load)	$I_C = 300A, V_{CC} = 600V$ $V_{GE} = \pm 15V, R_G = 2,4\Omega, T_{vj} = 25^\circ C$	$t_{d,on}$	-	0,25	-	μs
	$V_{GE} = \pm 15V, R_G = 2,4\Omega, T_{vj} = 125^\circ C$		-	0,30	-	μs
Anstiegszeit (induktive Last) rise time (inductive load)	$I_C = 300A, V_{CC} = 600V$ $V_{GE} = \pm 15V, R_G = 2,4\Omega, T_{vj} = 25^\circ C$	t_r	-	0,09	-	μs
	$V_{GE} = \pm 15V, R_G = 2,4\Omega, T_{vj} = 125^\circ C$		-	0,10	-	μs
Abschaltverzögerungszeit (induktive Last) turn off delay time (inductive load)	$I_C = 300A, V_{CC} = 600V$ $V_{GE} = \pm 15V, R_G = 2,4\Omega, T_{vj} = 25^\circ C$	$t_{d,off}$	-	0,55	-	μs
	$V_{GE} = \pm 15V, R_G = 2,4\Omega, T_{vj} = 125^\circ C$		-	0,65	-	μs
Fallzeit (induktive Last) fall time (inductive load)	$I_C = 300A, V_{CC} = 600V$ $V_{GE} = \pm 15V, R_G = 2,4\Omega, T_{vj} = 25^\circ C$	t_f	-	0,13	-	μs
	$V_{GE} = \pm 15V, R_G = 2,4\Omega, T_{vj} = 125^\circ C$		-	0,18	-	μs
Einschaltverlustenergie pro Puls turn on energy loss per pulse	$I_C = 300A, V_{CC} = 600V, L_\sigma = 80nH$ $V_{GE} = \pm 15V, R_G = 2,4\Omega, T_{vj} = 125^\circ C$	E_{on}	-	25	-	mJ
Ausschaltverlustenergie pro Puls turn off energy loss per pulse	$I_C = 300A, V_{CC} = 600V, L_\sigma = 80nH$ $V_{GE} = \pm 15V, R_G = 2,4\Omega, T_{vj} = 125^\circ C$	E_{off}	-	44	-	mJ
Kurzschlussverhalten SC data	$t_p \leq 10\mu s, V_{GE} \leq 15V, T_{vj} \leq 125^\circ C$ $V_{CC} = 900V, V_{CEmax} = V_{CES} - L_{\sigma CE} \cdot di/dt$	I_{SC}	-	1200	-	A
Modulinduktivität stray inductance module		$L_{\sigma CE}$	-	20	-	nH
Leitungswiderstand, Anschluss-Chip lead resistance, terminal-chip	$T_c = 25^\circ C$	$R_{CC/EE}$	-	0,7	-	m Ω

Charakteristische Werte / characteristic values

Inversdiode / free-wheel diode

Durchlassspannung forward voltage	$I_F = 300A, V_{GE} = 0V, T_{vj} = 25^\circ C$	V_F	-	1,65	2,15	V
	$I_F = 300A, V_{GE} = 0V, T_{vj} = 125^\circ C$		-	1,65	-	V
Rückstromspitze peak reverse recovery current	$I_F = 300A, -di_F/dt = 3000A/\mu s$ $V_R = 600V, V_{GE} = -15V, T_{vj} = 25^\circ C$	I_{RM}	-	210	-	A
	$V_R = 600V, V_{GE} = -15V, T_{vj} = 125^\circ C$		-	270	-	A
Sperrverzögerungsladung recovered charge	$I_F = 300A, -di_F/dt = 3000A/\mu s$ $V_R = 600V, V_{GE} = -15V, T_{vj} = 25^\circ C$	Q_r	-	30	-	μC
	$V_R = 600V, V_{GE} = -15V, T_{vj} = 125^\circ C$		-	56	-	μC
Ausschaltenergie pro Puls reverse recovery energy	$I_F = 300A, -di_F/dt = 3000A/\mu s$ $V_R = 600V, V_{GE} = -15V, T_{vj} = 25^\circ C$	E_{rec}	-	14	-	mJ
	$V_R = 600V, V_{GE} = -15V, T_{vj} = 125^\circ C$		-	26	-	mJ



Charakteristische Werte / characteristic values

Chopperdiode / chopper diode

Durchlassspannung forward voltage	$I_F=400A, V_{GE}=0V, T_{vj}=25^\circ C$	V_F	-	1,65	2,1	V
	$I_F=400A, V_{GE}=0V, T_{vj}=125^\circ C$		-	1,65	-	V
Rückstromspitze peak reverse recovery current	$I_F=400A, -di_F/dt=4000A/\mu s$	I_{RM}	-	280	-	A
	$V_R=600V, V_{GE}=-15V, T_{vj}=25^\circ C$ $V_R=600V, V_{GE}=-15V, T_{vj}=125^\circ C$		-	360	-	A
Sperrverzögerungsladung recovered charge	$I_F=400A, -di_F/dt=4000A/\mu s$	Q_r	-	40	-	μC
	$V_R=600V, V_{GE}=-15V, T_{vj}=25^\circ C$ $V_R=600V, V_{GE}=-15V, T_{vj}=125^\circ C$		-	75	-	μC
Ausschaltenergie pro Puls reverse recovery energy	$I_F=400A, -di_F/dt=4000A/\mu s$	E_{rec}	-	18	-	mJ
	$V_R=600V, V_{GE}=-15V, T_{vj}=25^\circ C$ $V_R=600V, V_{GE}=-15V, T_{vj}=125^\circ C$		-	34	-	mJ

Thermische Eigenschaften / thermal properties

Innerer Wärmewiderstand; DC thermal resistance, junction to case; DC	Transistor Wechler. / transistor inverter	R_{thJC}	-	-	0,085	K/W
	Inversdiode / free wheel diode		-	-	0,150	K/W
	Chopper Diode / chopper diode		-	-	0,125	K/W
Übergangs Wärmewiderstand thermal resistance, case to heatsink	pro Modul / per module $\lambda_{Paste}=1W/m^*K / \lambda_{grease}=1W/m^*K$	R_{thCK}	-	0,010	-	K/W
Höchstzulässige Sperrschichttemp. maximum junction temperature		$T_{vj\ max}$	-	-	150	$^\circ C$
Betriebstemperatur operation temperature		$T_{vj\ op}$	-40	-	125	$^\circ C$
Lagertemperatur storage temperature		T_{stg}	-40	-	125	$^\circ C$

Mechanische Eigenschaften / mechanical properties

Gehäuse, siehe Anlage case, see appendix						
Innere Isolation internal insulation				Al_2O_3		
CTI comperative tracking index				425		
Anzugsdrehmoment, mech. Befestigung mounting torque	Schraube M6 / screw M6	M	3,0	-	6,0	Nm
Anzugsdrehmoment, elektr. Anschlüsse terminal connection torque	Anschlüsse / terminals M6	M	2,5	-	5,0	Nm
Gewicht weight		G		340		g

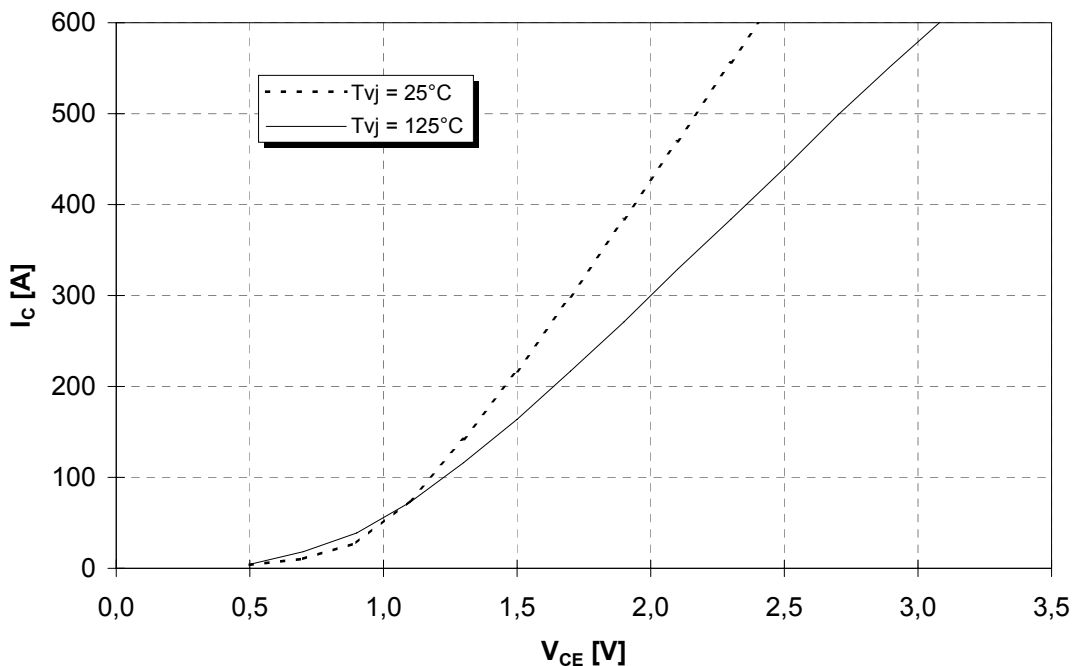
Mit dieser technischen Information werden Halbleiterbauelemente spezifiziert, jedoch keine Eigenschaften zugesichert. Sie gilt in Verbindung mit den zugehörigen technischen Erläuterungen.

This technical information specifies semiconductor devices but promises no characteristics. It is valid with the belonging technical notes.



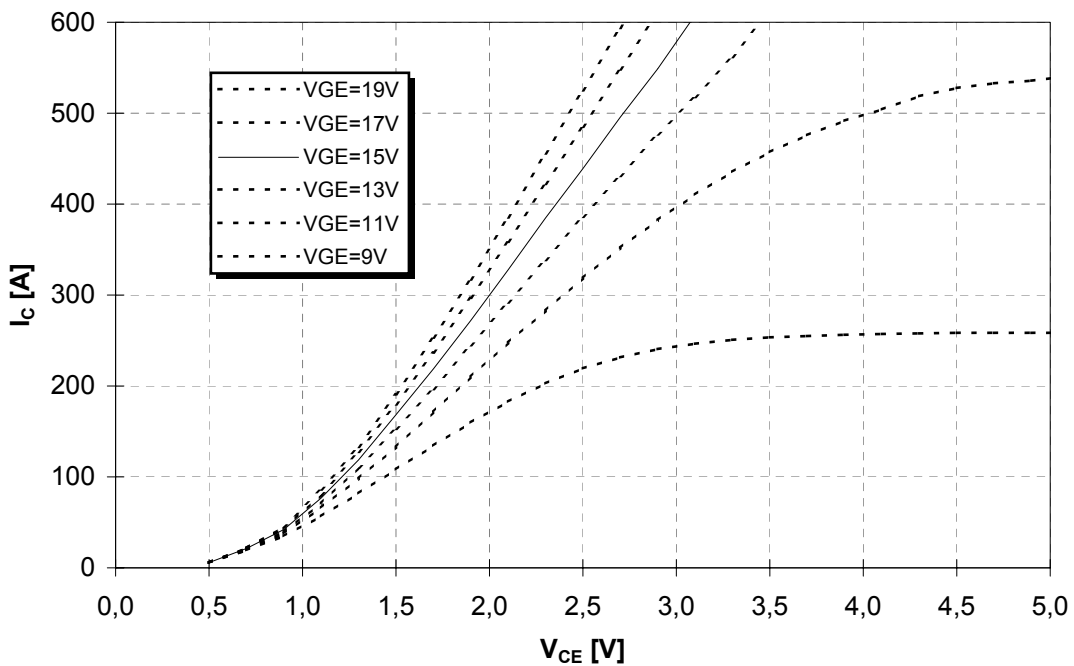
Ausgangskennlinie (typisch)
output characteristic (typical)

$I_C = f(V_{CE})$
 $V_{GE} = 15V$



Ausgangskennlinienfeld (typisch)
output characteristic (typical)

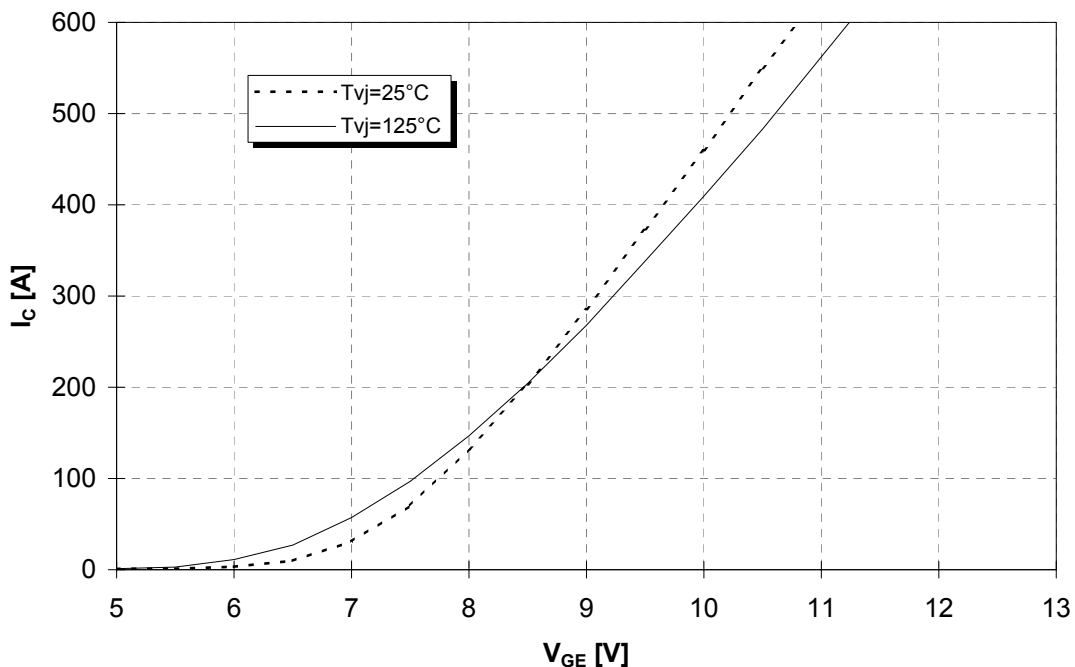
$I_C = f(V_{CE})$
 $T_{vj} = 125^\circ C$





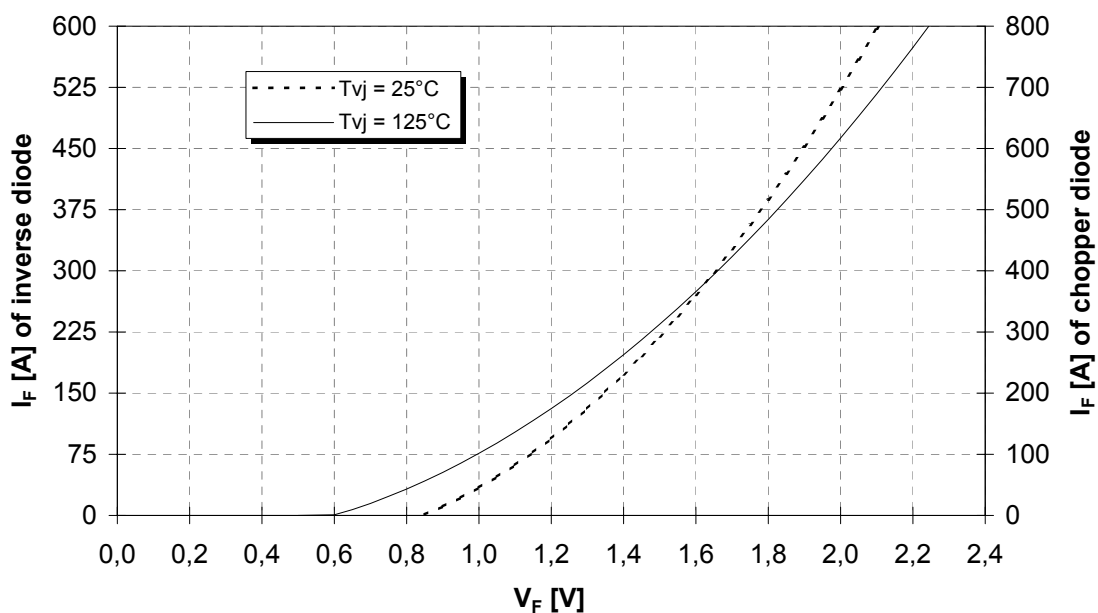
Übertragungscharakteristik (typisch)
transfer characteristic (typical)

$I_C = f(V_{GE})$
 $V_{CE} = 20V$



Durchlasskennlinie der Dioden (typisch)
forward characteristic of diodes (typical)

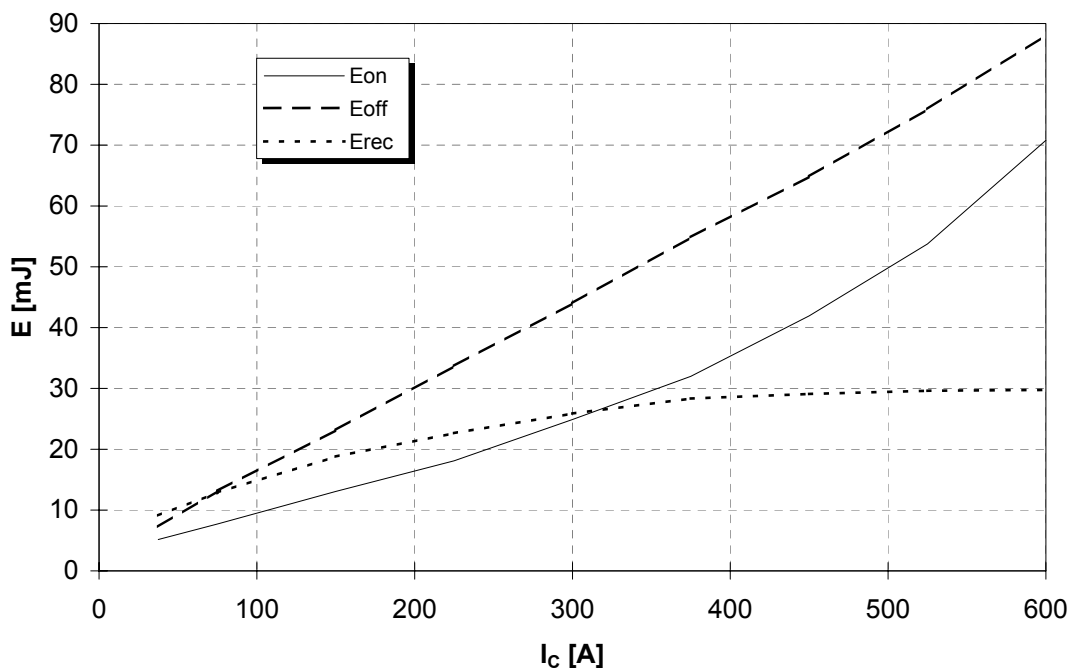
$I_F = f(V_F)$





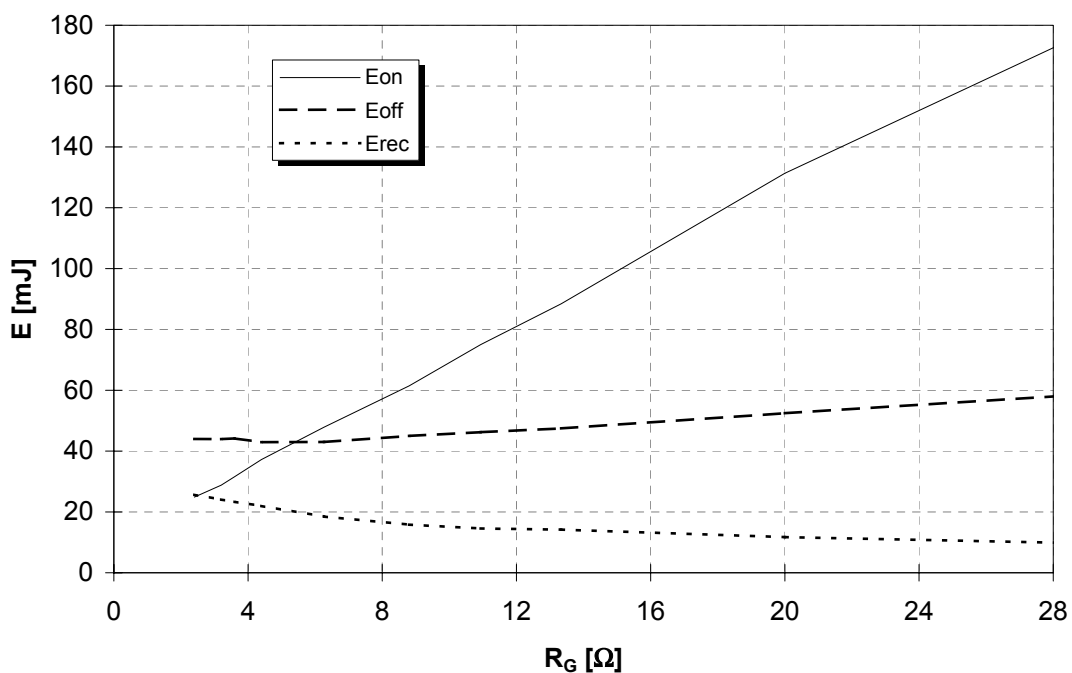
Schaltverluste (typisch)
Switching losses (typical)

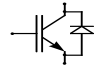
$E_{on} = f(I_C)$, $E_{off} = f(I_C)$, $E_{rec} = f(I_C)$
 $V_{GE} = \pm 15V$, $R_G = 2,4\Omega$, $V_{CE} = 600V$, $T_{vj} = 125^\circ C$



Schaltverluste (typisch)
Switching losses (typical)

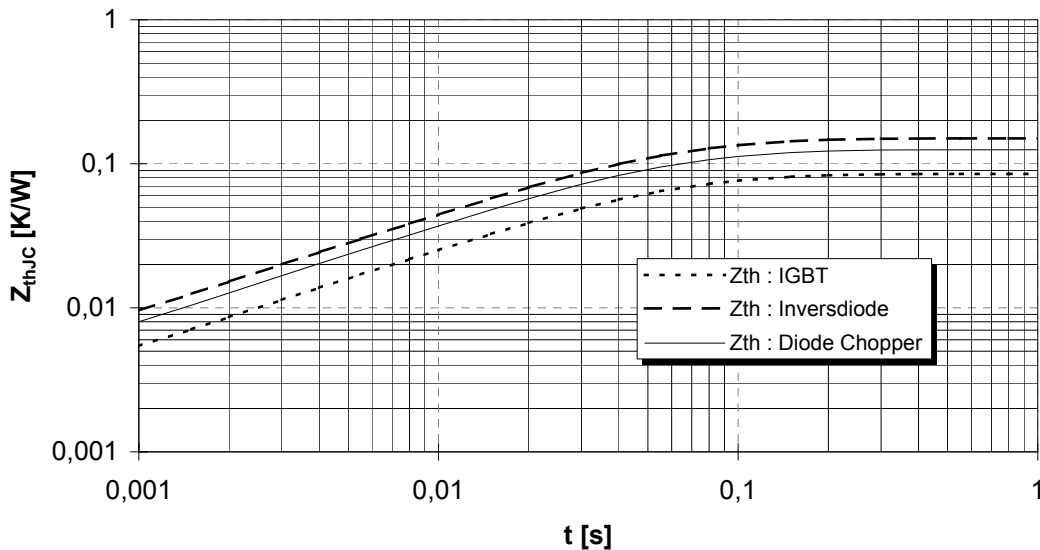
$E_{on} = f(R_G)$, $E_{off} = f(R_G)$, $E_{rec} = f(R_G)$
 $V_{GE} = \pm 15V$, $I_C = 300A$, $V_{CE} = 600V$, $T_{vj} = 125^\circ C$





Transienter Wärmewiderstand Transient thermal impedance

$$Z_{thJC} = f(t)$$

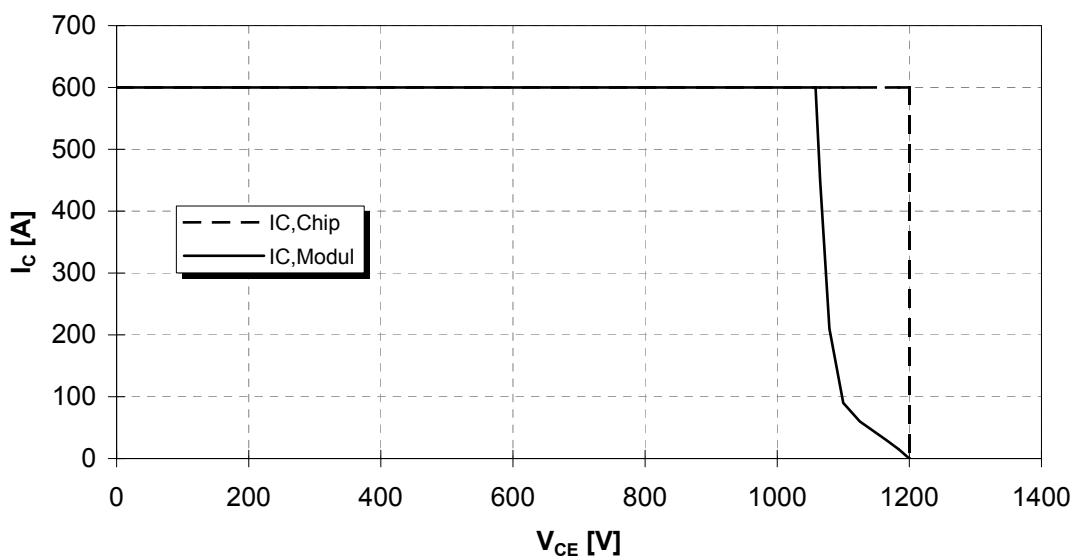


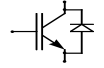
i	1	2	3	4
r_i [K/kW] : IGBT	35,73	42,82	4,84	1,61
τ_i [s] : IGBT	6,499E-02	2,601E-02	2,364E-03	1,187E-05
r_i [K/kW] : Inversdiode	62,99	75,66	8,52	2,83
τ_i [s] : Inversdiode	6,499E-02	2,601E-02	2,364E-03	1,187E-05
r_i [K/kW] : Chopper Diode	52,51	63,02	7,10	2,37
τ_i [s] : Chopper Diode	6,499E-02	2,601E-02	2,364E-03	1,187E-05

Sicherer Arbeitsbereich (RBSOA)

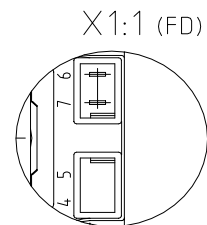
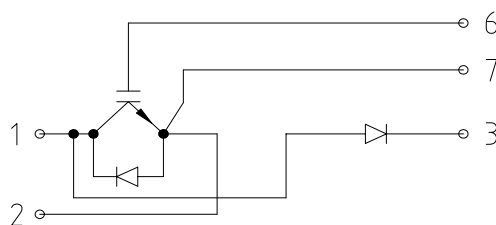
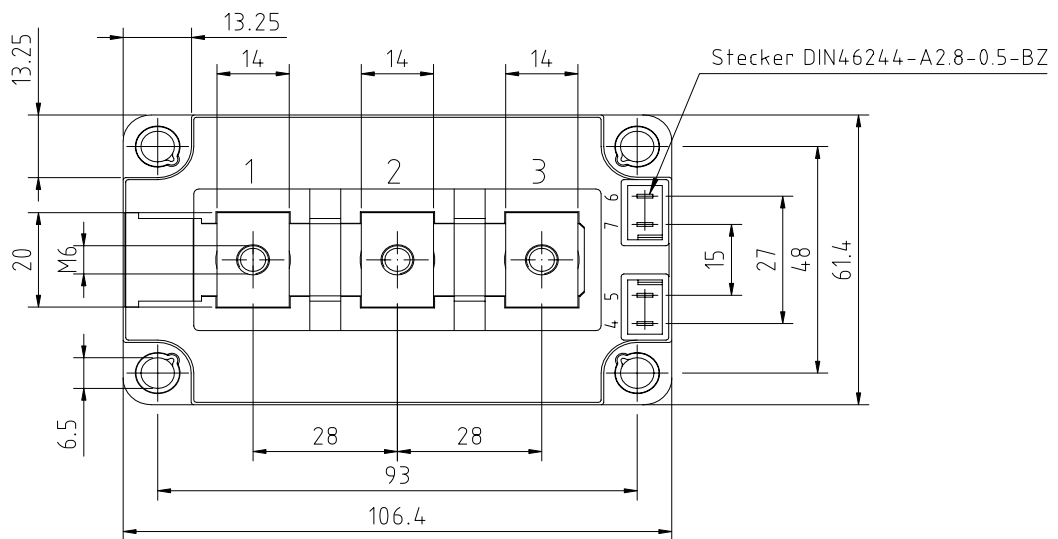
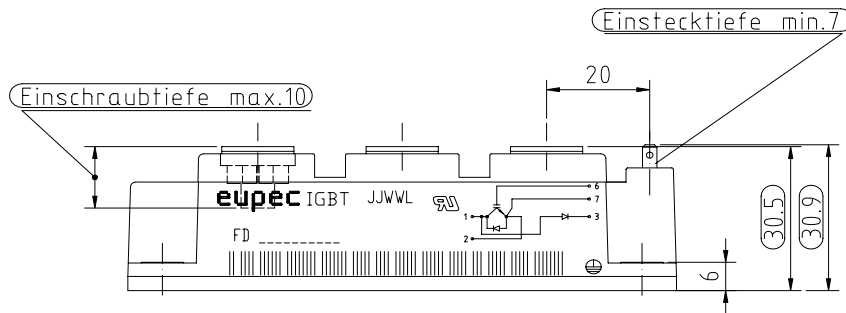
Reverse bias safe operation area (RBSOA)

$$V_{GE} = \pm 15V, T_{vj} = 125^\circ C, R_G = 2,4\Omega$$





Gehäusemaße / Schaltbild Package outline / Circuit diagram



Kriechstrecke creepage distance			20	mm
Luftstrecke clearance distance			11	mm

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